

# SANYO Semiconductors DATA SHEET

# LV5652T

# **Bi-CMOS LSI**

# **3-channel Switching Regulator Controller**

# Overview

The LV5652T is a 3-channel switching regulator controller.

#### **Features**

- Low-voltage (3V) operation
- Reference voltage precision : ±1%
- Independent standby functions for each of three channels.
- Is capable of driving MOS transistors.

• switching regulator controller : 3-channel

ch1: Supports synchronous rectification

ch2: Supports inverting step-up operation

ch3: Supports step-up operation

# **Specifications**

# **Maximum Ratings** at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage 1	V <sub>CC</sub> max	V <sub>CC</sub> pin	-0.3 to 16	٧
Maximum supply voltage 2	VBIAS max	VBIAS pin	-0.3 to 18	٧
Maximum clock input voltage	VCLKIN max	CLKIN pin	5.5	٧
Allowable power dissipation	Pd max	Mounted on a specified board*	1	W
Operating temperature	Topr		-30 to +85	°C
Storage temperature	Tstg		-55 to +125	°C

<sup>\*</sup> Specified board: 114.3mm  $\times$  76.1mm  $\times$  1.6mm, glass epoxy board.

### Recommended Operating Conditions at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage 1	V <sub>CC</sub>	V <sub>CC</sub> pin	3 to 15	V
Supply voltage 2	VBIAS	VBIAS pin	3 to 15	V
Clock input voltage	VCLKIN	CLKIN pin	5	V
Timing resistor	RT		7 to 30	kΩ
Timing capacitor	СТ		100 to 1000	pF
Triangle wave frequency	fosc		0.1 to 1.3	MHz

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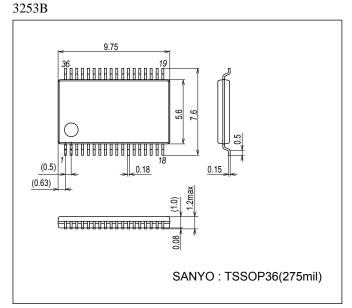
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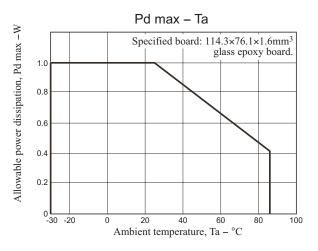
# 

Parameter				Ratings			
Parameter  Error amplifier 1		Symbol	Conditions	min	typ	max	Unit
Error amplifier 1							
IN <sup>+</sup> pin internal bias v	oltage	VB	Value added to the error amplifier offset at the error amplifier + side voltage	0.504	0.51	0.516	V
Output low voltage	ch1 to ch3	V <sub>Low</sub> FB	IN <sup>-</sup> = 2.0V, IFB = 20μA			0.2	V
Output high voltage	ch1 to ch3	V <sub>Hi</sub> FB	IN <sup>-</sup> = 0V, IFB1 = -20μA	2.0			V
Error amplifier 2							
IN2 <sup>-</sup> RE pin offset volta	age	VOFF2		-6		6	V
Output low voltage		V <sub>Low</sub> FB2RE	IN2-RE = 2.0V, IFB = 20μA			0.2	V
Output high voltage		V <sub>Hi</sub> FB2RE	IN2-RE = -10V, IFB1 = -500μA	2.0			V
Protection circuit				•			
Threshold voltage		V <sub>SCP</sub>		1.1	1.25	1.4	V
SCP pin current		I <sub>SCP</sub>			4		μА
Short circuit detection signal pin		VSCPOUT	Open collector, ISCPOUT = 100μA			0.2	V
Software start block		•					
Soft start current	ch1 to ch3	I <sub>SF</sub>	CSOFT = 0V	3.2	4	4.8	μА
Soft start resistance	ch1 to ch3	R <sub>SF</sub>		160	200	240	kΩ
Fixed duty		•					
Maximum on duty 1	ch1	Duty MAX 1	Out monitor , IN <sup>-</sup> = 0V	100			%
Maximum on duty 2	ch2	Duty MAX 2	Out monitor , IN <sup>-</sup> = 0V	80	85	90	%
Maximum on duty 3	ch3	Duty MAX 3	Out monitor , IN <sup>-</sup> = 0V	80	85	90	%
Output block	ı	•		<u> </u>	l.		
OUT pin high side on	resistance	R <sub>OUT</sub> SOUR	I <sub>O</sub> = 10mA		28	50	Ω
OUT pin low side on r	esistance	R <sub>OUT</sub> SINK	I <sub>O</sub> = 10mA		18	35	Ω
Triangle wave oscilla	ator block	•		W.	<u> </u>		
Current setting pin vo	Itage	VT RT	RT = 10kΩ		0.57		V
Output current		IOH CT			190		μА
Output current ratio		ΔIO CT	CT pin, rise/fall	2	2.5	3	-
Oscillation frequency		fosc	RT = $10k\Omega$ , CT = $270pF$	390	510	620	kHz
Reference voltage b	lock	•					
Reference voltage		VREF			1.240		V
Line regulation		V <sub>LN</sub> REF	V <sub>CC</sub> = 3V to 15V			10	mV
Control circuit		•					
On state voltage		V <sub>ON</sub> CTL		2.0			V
OFF state voltage		V <sub>OFF</sub> CTL				0.6	V
Pin input current		I <sub>IN</sub> CTL				60	μА
Standby circuit		•					
On voltage		V <sub>ON</sub> STBY		2.0			V
OFF voltage		V <sub>OFF</sub> STBY				0.6	V
Pin input current		I <sub>IN</sub> STBY				60	μА
All circuits				L			
V <sub>CC</sub> current consump	otion	Icc	IN1 <sup>-</sup> to IN3 <sup>-</sup> = 1V		4	5	mA
Standby mode curren	t consumption	l <sub>OFF</sub>	VSTBY = VCTL = 0V, I <sub>OFF</sub> = I <sub>CC</sub> + I <sub>BIAS</sub>			1	μА
					l l		

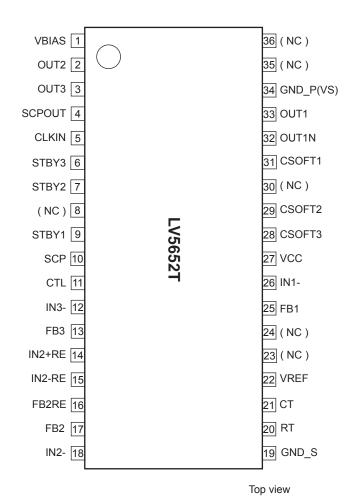
# **Package Dimensions**

unit: mm (typ)

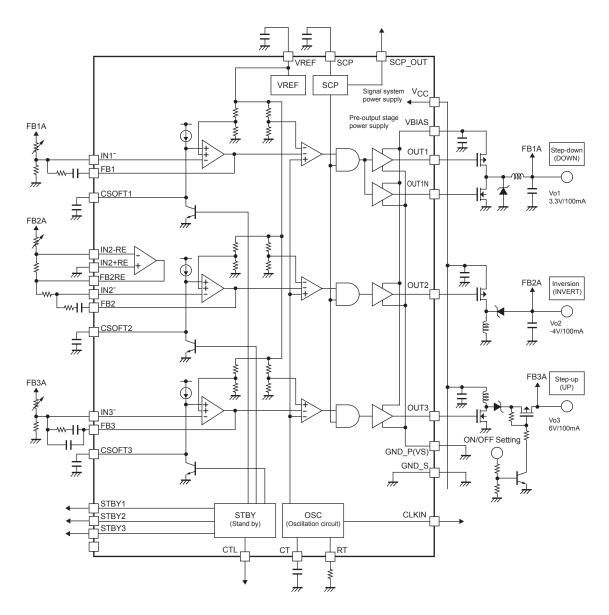




# **Pin Assignment**



# **Block Diagram and Sample Application Circuit**



The CLKIN pin must be connected to GND, when the external clock synchronization (CLKIN) is not used.

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# **Pin Function**

Block	Pin No.	Pin Name	Functions
ch1	9	STBY1	Standby input. H/ch1; ON, L/ch1; OFF.
(Step-down)	26	IN1 <sup>-</sup>	Error amplifier Inverting input.
	25	FB1	Error amplifier output.
	31	CSOFT1	Soft start setting capacitor connection. Connect to GND through a capacitor.
	33	OUT1	Output. External transistor P-channel gate connection.
	32	OUT1N	Output. External transistor N-channel gate connection.
ch2	7	STBY2	Standby input. H/ch2; ON, L/ch2; OFF.
(Inversion)	14	IN2 <sup>+</sup> RE	Inversion amplifier, +(noninverting) input.
	15	IN2-RE	Inversion amplifier, -(Inverting) input.
	16	FB2RE	Inversion amplifier output.
	18	IN2-	Error amplifier, - (Inverting) input.
	17	FB2	Error amplifier output.
	29	CSOFT2	Soft start setting capacitor connection. Connect to GND through a capacitor.
	2	OUT2	Output. External transistor P-channel gate connect.
ch3	6	STBY3	Standby input. H/ch3; ON, L/ch3; OFF.
(Step-up)	12	IN3-	Error amplifier, - (Inverting) input.
	13	FB3	Error amplifier output.
	28	CSOFT3	Soft start setting capacitor connection. Connect to GND through a capacitor.
	3	OUT3	Output. External transistor N-channel gate connect.
POWER	27	VCC	Power supply input (signal system).
	1	VBIAS	Power supply input (pre-output stage).
	19	GND_S	Ground (signal system).
	34	GND_P (VS)	Ground (pre-output stage).
	22	VREF	Reference voltage output.
CONTROL	11	CTL	Output control.
	10	SCP	Connection pin for the delay time setting capacitor of short circuit detection circuit.
	4	SCPOUT	SCP_OUT pin (SCP output).
OSC	21	СТ	Triangle wave oscillation frequency setting capacitor connection.
	20	RT	Triangle wave oscillation frequency setting resistor connection.
	5	CLKIN	External clock input.
OTHER	8	(NC)	Not use.
	23	(NC)	Not use.
	24	(NC)	Not use.
	30	(NC)	Not use.
	35	(NC)	Not use.
	36	(NC)	Not use.

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# **Equivalent Circuits**

Equivai	ent Circuit	S	
Pin No.	Pin Name	Description	Equivalent Circuit
11 9 7 6	CTL STBY1 STBY2 STBY3	CTL : Controls operation of all circuits.  STBY* : Independently controls operation of the corresponding channel.  Operation is high active.  High: ON  Low: OFF	CTL/STBY*  \$120kΩ  \$30kΩ  GND_S
26 18 12	IN1- IN2- IN3-	Error amplifier inverting input. The regulator output is divided by a resistor and connected to IN*-	VREG (Internal constant voltage)
25 17 13	FB1 FB2 FB3	Error amplifier output.  These pins, in combination with IN*-, configure the error amplifier filters	VREG (Internal constant voltage)  20Ω\$  FB*  GND_S
14 15	IN2 <sup>+</sup> RE IN2 <sup>-</sup> RE	Inversion step-up (Channel2) error amplifier input. These pins, in combination with FB2RE,configure the operational amplifier (independent)	VREG (Internal constant voltage)  IN2-RE  500Ω  S5kΩ  S5kΩ  GND_S
16	FB2RE	Inversion step-up (Channel2) error amplifier output. This pin, in combination with IN2 <sup>+</sup> RE and IN2 <sup>-</sup> RE, configures the operational amplifier (independent)	VREG (Internal constant voltage)  FR2RE GND_S

Continued on next page.

Continued from preceding page. Pin No. Pin Name Description **Equivalent Circuit** CSOFT1 31 Soft start. VREG CSOFT2 Connect to GND via a capacitor to set the 29 (Internal constant CSOFT3 28 soft start time. voltage)  $500\Omega$ CSOFT\* \_\_\_\_\_ 10kΩ ≹200kΩ OND\_S 33 OUT1 Output. ) VBIAS 2 OUT2 Connect external PchFET. 3 OUT3 OUT\* ( GND\_P (VS) 32 OUT1N Output. ) VBIAS Connect external NchFET. VOUT1N( GND\_P (VS) 20 RT Connect to GND through a resistor. **VREG** This pin, together eith CT, sets the (Internal constant oscillation frequency. voltage) ≸ 500Ω RT ( \_W\_ 500Ω GND\_S 21 Connect to GND through a capacitor. СТ **VREG** This pin, together eith RT, sets the (Internal constant oscillation frequency. voltage) GND\_S 4 SCP\_OUT Short circuit detection circuit output. When SCP exceeds the threshold voltage, (Internal constant the open collector goes OFF and this pin voltage) SCP\_OUT( goes High. )GND\_S

Continued on next page.

22 VREF Interior Conf	Description  nect to GND via a capacitor to set the  rt circuit detection circuit delay time.	SCP VREG (Internal constant voltage)  VREG (Internal constant voltage)  VREG (Internal constant voltage)
22 VREF Interior Conf	t circuit detection circuit delay time.	SCP (Internal constant voltage)  \$1.5kΩ  GND_S  VREG
5 CLKIN Exter		
Apply		VREF 14.8kΩ\$  GND_S
	ernal clock input.  y an external clock of the internal lation frequency or higher.	VREG (Internal constant voltage)  CLKIN  GND_S
27 V <sub>CC</sub> Signa	al system power supply	Vcc
(Outp	er system power supply put stage)	VBIAS
	al system GND	GND_S O
	out stage GND (pre-stage)	GND_P (VS)
	prohibited.	
	connect pins.)	
24 (NC)		( NC )
30 (NC)	,	, , )
35 (NC) 36 (NC)		

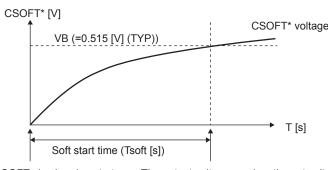
#### **Notes**

#### (1) Soft start time setting method

The soft start time is set with the capacitor connected between CSOFT\* and GND S.

This IC has an independent soft start function for each channel, so a capacitor must be connected for each CSOFT to set the soft start time.

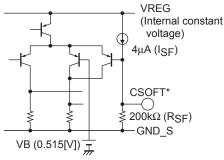
(Description of soft start operation)



CSOFT pin charging starts

The output voltage reaches the set voltage (Output voltage constant)

(Outline of soft start pin)



$$T_{SOFT} = C_{SOFT} \times R_{SF} \ln \left( \frac{VB}{R_{SF} \times I_{SF}} \right)$$
$$= 0.206 \times 10^{6} \times C_{SOFT} [s]$$

# (2) Setting the oscillation frequency

The internal oscillation frequency is set by the resistor connected to the RT pin and the capacitor connected to the CT pin. The waveform generated on CT is a triangular wave with the charging/discharging waveform determined by RT and CT.

$$f_{OSC} = 1.32 \text{ X} \frac{1}{\text{CT X RT}} \text{ [Hz]}$$

The actual internal oscillation frequency deviates from the calculated value due to overshoot, undershoot and other factors, so the frequency should be confirmed in an actual set.

### (3) External input CLK function (CLK\_IN)

Switching operation can be synchronized with external clock input (CLK\_IN) by using the CLK\_IN pin.

• External clock (CLK\_IN) frequency and input level

When using external clock (CLK\_IN) input, input a frequency equal to the internal oscillation frequency +20% or more to CLK\_IN. In addition, the CLK\_IN configuration is shown in the figure "CLK\_IN (input) equivalent circuit (outline)" below.

The 0.8V reference voltage and CLK\_IN are compared to determine the edges, so input a signal of 0.8V or more (V<sub>CC</sub> voltage or less) as the external clock (CLK\_IN).

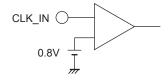
• External/internal clock switching

Set the CTL pin Low before switching between the external clock and the internal clock. Switching clocks when running may give rise to output voltage fluctuations.

• Maximum ON duty

The maximum ON duty (Duty\_MAX\*) of channel 2 to channel 3 is the 85% (typ.) setting. When using the external clock (CLK\_IN), the maximum ON duty (Duty\_MAX\*) becomes smaller, so care must be taken for the set output voltage.

(CLK\_IN (input) equivalent circuit (outline))



#### (4) SCP (short circuit protection) function

• Description of operation

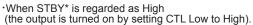
When any one of FB1 to FB4 goes High due to the load being shorted or other reason, charging to the SCP pin starts. If output does not recover during the set time Tscp and SCP pin voltage exceeds the threshold voltage, the protective circuit (SCP) operates and all channel outputs are turned OFF. All outputs are latched off by the protection circuit (SCP). This latched state (output OFF) is canceled by setting the CTL pin Low or by turning the power supply OFF. When not using the protection function (SCP), the SCP pin must be shorted to GND\_S with a line that is as short as possible.

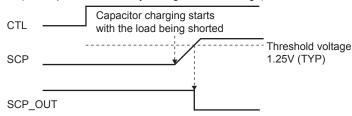
The SCP operation time is set by the capacitor connected to the SCP pin.

#### (SCP charging operation)

# Charging with Iscp = 4 [µA] 1.25 [V] (TYP) T [s] Output short circuit SCP operation

#### (SCP function)





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